

4

Specifications

Material

Insulator: LCP, UL 94V-0, Black Contact: Copper Alloy (C1814), T=0.12mm Mid Plate: Stainless Steel (SUS301), T=0.15mm Shell: Stainless Steel (SUS304), T=0.30mm

Plating

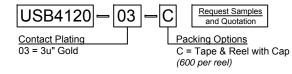
Contact Contact Area: 3u" Au over 50µ" min. Nickel Solder Tails: Gold Flash over 50µ" min. Nickel Shell: 30µ" min. Nickel Mid Plate: Cleaning

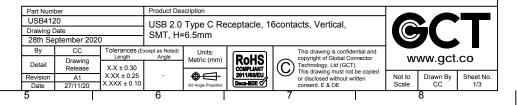
Electrical

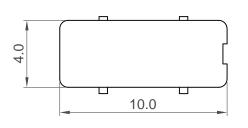
Current Rating: 5.00A collectively for VBUS pins 6.25A collectively for GND pins 1.25A for B5 pin 0.25A per pin for all other pins Voltage Rating: 20V DC Contact Resistance: 40mQ max initial. $50m\Omega$ max after test Dielectric Withstanding Voltage: 100V AC Insulation Resistance 100MΩ min Mechanical & Environmental Operating Temperature: -25°C to +85°C Mating Force: 5 to 20 N.

Unmated Force: 6 to 20 N after test Durability: 10,000 cycles

Ordering Grid







G

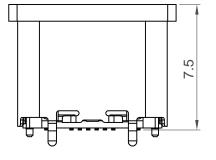
F

F

D

R

1

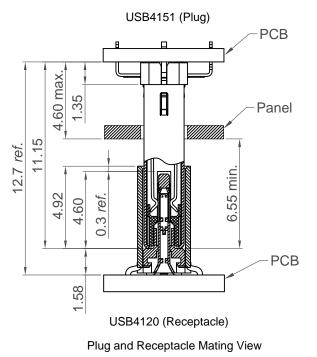


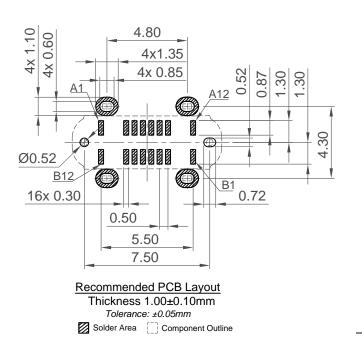
Cap Information

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Mating Mating Signal Signal Pin Pin Sequence Sequence GND A1 First B12 GND First A4 VBUS First B9 VBUS First A5 CC1 SBU2 Second B8 Second B7 A6 Dp1 Dn2 Second Second A7 Dn1 Second B6 Dp2 Second A8 SBU1 Second B5 CC2 Second A9 VBUS First Β4 VBUS First A12 GND B1 GND First First SHELL GND SHELL GND

